

07-23-2003



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DELPHI TECHNOLOGIES, INC.

Legal Staff MC CT10C

P.O. Box 9005

Kokomo, Indiana 46904-9005

7-14-03

Mail Stop Assignment Recordation Services
 Director of the United States Patent and Trademark Office
 P.O. Box 1450
 Alexandria, Virginia 22313-1450

7-14-03

Enclosed for recording is Assignment documentation for the following patent application:

Attorney Docket No. : DP-309697

(1) Assignor/Inventors : SCOTT D. BRANDENBURG
 DAVID A. LAUDICK

(2) Assignee : DELPHI TECHNOLOGIES, INC.
 Legal Staff - Mail Code : 480-410-202
 P.O. Box 5052
 TROY, MICHIGAN

(3) Assignment of patent application

(4) Application number:

10618953

If blank, this documentation is filed together with the patent application.

(5) Address correspondence to : STEFAN V. CHMIELEWSKI
 DELPHI TECHNOLOGIES, INC.
 Legal Staff MC CT10C
 P.O. Box 9005
 Kokomo, Indiana 46904-9005

(6) Number of applications : 1
 Total Fee : 40.00

(7) Date documentation executed: July 8, 2003

(8) Not applicable

(9) To the best of my knowledge and belief, the information contained on this cover sheet is true and correct and any copy submitted is a true copy of the original document.

Title : WAFER APPLIED THERMALLY CONDUCTIVE INTERPOSER

Please charge the \$ 40.00 assignment recording fee to DELPHI TECHNOLOGIES INC., Deposit Account No. 50-0831.

07/22/2003 BYRNE 00000260 500831 10618953

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STEFAN V. CHMIELEWSKI
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Total number of pages including cover sheet, attachments and document: _____

Enclosures

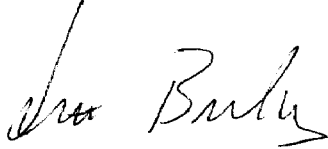
16235 U.S. PTO
 10/618953
 07/14/03

ASSIGNMENT

Pursuant to an agreement with my employer, I formally assign to DELPHI TECHNOLOGIES INC., the entire right, title and interest, in all countries, in the improvements set forth in the United States patent application DP-309697 entitled

WAFER APPLIED THERMALLY CONDUCTIVE INTERPOSER

for which I executed a declaration dated as indicated below. If the patent application has been filed, I authorize attorney STEFAN V. CHMIELEWSKI to insert the application number and filing date of said application here in parentheses (_____ filed _____) when known.

Inventor's signature  Date 7/8/03

Full name : SCOTT D. BRANDENBURG

Declaration dated :

Residence : KOKOMO, INDIANA

7/8/03

Inventor's signature  Date 7/8/2003

Full name : DAVID A. LAUDICK

Declaration dated :

Residence : KOKOMO, IN

7/8/03